

# LMH6554 2.8 GHz Ultra Linear Fully Differential Amplifier

Check for Samples: LMH6554

#### **FEATURES**

- **Small Signal Bandwidth 2.8 GHz**
- 2 V<sub>PP</sub> Large Signal Bandwidth 1.8 GHz
- 0.1 dB Gain Flatness 830 MHz
- OIP3 @ 150 MHz 46.5 dBm
- HD2/HD3 @ 75 MHz -96 / -97 dBc
- Input Noise Voltage 0.9 nV/√Hz
- Input Noise Current 11 pA/√Hz
- Slew Rate 6200 V/µs
- Power 260mW
- **Typical Supply Current 52 mA**
- Package 14 Lead UQFN

#### **APPLICATIONS**

- **Differential ADC Driver**
- Single-Ended to Differential Converter
- **High Speed Differential Signaling**
- IF/RF and Baseband Gain Blocks
- SAW Filter Buffer/Driver
- **Oscilloscope Probes**
- **Automotive Safety Applications**
- Video Over Twisted Pair
- **Differential Line Driver**

# **Typical Application**

#### DESCRIPTION

The LMH6554 is a high performance fully differential amplifier designed to provide the exceptional signal fidelity and wide large-signal bandwidth necessary for driving 8 to 16 bit high speed data acquisition systems. Using TI's proprietary differential current mode input stage architecture, the LMH6554 has unity gain, small-signal bandwidth of 2.8 GHz and allows operation at gains greater than unity without sacrificing response flatness, bandwidth, harmonic distortion, or output noise performance.

The device's low impedance differential output is designed to drive ADC inputs and any intermediate filter stage. The LMH6554 delivers 16-bit linearity up to 75 MHz when driving 2V peak-to-peak into loads as low as  $200\Omega$ .

The LMH6554 is fabricated in Texas Instruments' advanced complementary BiCMOS process and is available in a space saving 14 lead UQFN package for higher performance.

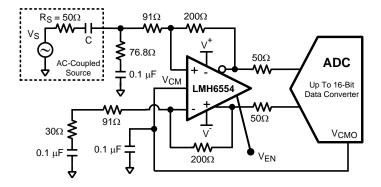


Figure 1. Single to Differential ADC Driver

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet. All trademarks are the property of their respective owners.





These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Absolute Maximum Ratings (1)(2)

| ESD Tolerance (3)  | Human Body Model    | 2000V                                 |
|--|---------------------|---------------------------------------|
|  | Machine Model       | 250V                                  |
|  | Charge Device Model | 750V                                  |
| Supply Voltage (V <sub>S</sub> = V <sup>+</sup> - V <sup>-</sup> ) | 5.5V                |                                       |
| Common Mode Input Voltage  |                     | From V <sup>-</sup> to V <sup>+</sup> |
| Maximum Input Current  |                     | 30mA                                  |
| Maximum Output Current (pins 12, 13)                               | (4)                 |                                       |
| Soldering Information  |                     |                                       |
| Infrared or Convection (30 sec)                                    |                     | 260°C                                 |
| For soldering specifications see SNOA549                           |                     |                                       |

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not ensured. For ensured specifications, see the Electrical Characteristics tables.
- (2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/ Distributors for availability and specifications.
- (3) Human Body Model, applicable std. MIL-STD-883, Method 30157. Machine Model, applicable std. JESD22-A115-A (ESD MM std. of JEDEC). Field-Induced Charge-Device Model, applicable std. JESD22-C101-C (ESD FICDM std. of JEDEC).
- (4) The maximum output current (I<sub>OUT</sub>) is determined by device power dissipation limitations. See the Power Dissipation section of Application Information for more details.

# Operating Ratings (1)

| Operating Temperature Range            | −40°C to +125°C |
|--|-----------------|
| Storage Temperature Range              | −65°C to +150°C |
| Total Supply Voltage Temperature Range | 4.7V to 5.25V   |

<sup>(1)</sup> Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not ensured. For ensured specifications, see the Electrical Characteristics tables.

#### **Thermal Properties**

| Junction-to-Ambient Thermal Resistance ( $\theta_{JA}$ ) | 60°C/W |
|--|--------|
| Maximum Operating Junction Temperature                   | 150°C  |



# +5V Electrical Characteristics (1)

Unless otherwise specified, all limits are ensured for  $T_A = +25^{\circ}C$ ,  $A_V = +2$ ,  $V^+ = +2.5V$ ,  $V^- = -2.5V$ ,  $R_L = 200\Omega$ ,  $V_{CM} = (V^+ + V^-)/2$ ,  $R_F = 200\Omega$ , for single-ended in, differential out. Boldface Limits apply at the temperature extremes.

| Symbol                              | Parameter  | Conditions  | Min <sup>(2)</sup> | Typ <sup>(3)</sup> | Max (2) | Units              |  |  |  |  |
|-------------------------------------|--|---|--------------------|--------------------|---------|--------------------|--|--|--|--|
| AC Perforn                          | nance (Differential)   |   |                    | •                  |         |                    |  |  |  |  |
|                                     |  | $A_V = 1$ , $V_{OUT} = 0.2 V_{PP}$                            |                    | 2800               |         |                    |  |  |  |  |
| SSBW                                | Small Signal -3 dB Bandwidth (2)                                   | $A_V = 2$ , $V_{OUT} = 0.2 V_{PP}$                            |                    | 2500               |         | MHz                |  |  |  |  |
|                                     |  | $A_V = 4$ , $V_{OUT} = 0.2 V_{PP}$                            |                    |                    |         |                    |  |  |  |  |
|                                     |  | $A_V = 1$ , $V_{OUT} = 2 V_{PP}$                              |                    | 1800               |         |                    |  |  |  |  |
| LSBW                                | Large Signal Bandwidth   | $A_V = 2$ , $V_{OUT} = 2$ $V_{PP}$                            |                    | 1500               |         | MHz                |  |  |  |  |
|                                     |  | A <sub>V</sub> = 2, V <sub>OUT</sub> = 1.5 V <sub>PP</sub>    |                    | 1900               |         |                    |  |  |  |  |
| 0.1 dBBW                            | 0.1 dB Bandwidth   | $A_V = 2$ , $V_{OUT} = 0.2 V_{PP}$ , $R_F = 250 \Omega$       |                    | 830                |         | MHz                |  |  |  |  |
| SR                                  | Slew Rate  | 4V Step   |                    | 6200               |         | V/µs               |  |  |  |  |
|                                     | D: /E !! T:  | 2V Step, 10-90%   |                    | 290                |         |                    |  |  |  |  |
| t <sub>r</sub> /t <sub>f</sub>      | Rise/Fall Time   | 0.4V Step, 10-90%   |                    | 150                |         | ps                 |  |  |  |  |
| T <sub>s_0.1</sub>                  | 0.1% Settling Time   | 2V Step, R <sub>L</sub> = 200Ω                                |                    | 4                  |         | ns                 |  |  |  |  |
|                                     | Overdrive Recovery Time  | V <sub>IN</sub> = 2V, A <sub>V</sub> = 5 V/V                  |                    | 6                  |         | ns                 |  |  |  |  |
| Distortion                          | and Noise Response   |   |                    |                    |         |                    |  |  |  |  |
|                                     |  | V <sub>OUT</sub> = 2 V <sub>PP</sub> , f = 20 MHz             |                    | -102               |         |                    |  |  |  |  |
|                                     | 2 <sup>nd</sup> Harmonic Distortion                                | V <sub>OUT</sub> = 2 V <sub>PP</sub> , f = 75 MHz             |                    | -96                |         |                    |  |  |  |  |
| HD2                                 |  | V <sub>OUT</sub> = 2 V <sub>PP</sub> , f = 125 MHz            |                    | -87                |         | dBc                |  |  |  |  |
|                                     |  | V <sub>OUT</sub> = 2 V <sub>PP</sub> , f = 250 MHz            |                    | -79                |         |                    |  |  |  |  |
|                                     |  | V <sub>OUT</sub> = 1.5 V <sub>PP</sub> , f = 250 MHz          |                    | -81                |         |                    |  |  |  |  |
|                                     | 3 <sup>rd</sup> Harmonic Distortion                                | V <sub>OUT</sub> = 2 V <sub>PP</sub> , f = 20 MHz             |                    | -110               |         | dBc                |  |  |  |  |
|                                     |  | V <sub>OUT</sub> = 2 V <sub>PP</sub> , f = 75 MHz             |                    | -97                |         |                    |  |  |  |  |
| HD3                                 |  | V <sub>OUT</sub> = 2 V <sub>PP</sub> , f = 125 MHz            |                    | -87                |         |                    |  |  |  |  |
|                                     |  | V <sub>OUT</sub> = 2 V <sub>PP</sub> , f = 250 MHz            |                    | <b>-</b> 70        |         |                    |  |  |  |  |
|                                     |  | V <sub>OUT</sub> = 1.5 V <sub>PP</sub> , f = 250 MHz          |                    | <b>-</b> 75        |         |                    |  |  |  |  |
| OIP3                                | Output 3rd-Order Intercept   | f = 150 MHz, V <sub>OUT</sub> = 2V <sub>PP</sub> Composite    |                    | 46.5               |         | dBm                |  |  |  |  |
| IMD3                                | Two-Tone Intermodulation   | f = 150 MHz, V <sub>OUT</sub> = 2V <sub>PP</sub> Composite    |                    | -97                |         | dBc                |  |  |  |  |
| e <sub>n</sub>                      | Input Voltage Noise Density  | f = 10 MHz  |                    | 0.9                |         | nV/√Hz             |  |  |  |  |
| i <sub>n+</sub>                     | Input Noise Current  | f = 10 MHz  |                    | 11                 |         | pA/√ <del>Hz</del> |  |  |  |  |
| i <sub>n-</sub>                     | Input Noise Current  | f = 10 MHz  |                    | 11                 |         | pA/√Hz             |  |  |  |  |
| NF                                  | Noise Figure <sup>(4)</sup>  | 50Ω System, A <sub>V</sub> = 7.3, 100 MHz                     |                    | 7.7                |         | dB                 |  |  |  |  |
| Input Char                          | acteristics  |   | •                  | •                  | •       | •                  |  |  |  |  |
| I <sub>BI+</sub> / I <sub>BI-</sub> |  |   | <b>-</b> 75        | -29                | 20      | μA                 |  |  |  |  |
| TClbi                               | Input Bias Current Temperature Drift                               |   |                    | 8                  |         | μΑ/°C              |  |  |  |  |
| I <sub>BID</sub>                    | Input Bias Current (5)   | $V_{CM} = 0V, V_{ID} = 0V,$ $I_{BOFFSET} = (I_{B-} I_{B+})/2$ | -10                | 1                  | 10      | μА                 |  |  |  |  |
| TClbo                               | Input Bias Current Diff Offset<br>Temperature Drift <sup>(3)</sup> |   |                    | 0.006              |         | μΑ/°C              |  |  |  |  |
| CMRR                                | Common Mode Rejection Ratio  | DC, $V_{CM} = 0V$ , $V_{ID} = 0V$                             |                    | 83                 |         | dB                 |  |  |  |  |

<sup>(1)</sup> Electrical Table values apply only for factory testing conditions at the temperature indicated. Factory testing conditions result in very limited self-heating of the device such that T<sub>J</sub> = T<sub>A</sub>. No specification of parametric performance is indicated in the electrical tables under conditions of internal self-heating where T<sub>J</sub> > T<sub>A</sub>. See Application Information for information on temperature de-rating of this device." Min/Max ratings are based on product characterization and simulation. Individual parameters are tested as noted.

<sup>(2)</sup> Limits are 100% production tested at 25°C. Limits over the operating temperature range are ensured through correlation using Statistical Quality Control (SQC) methods.

<sup>(3)</sup> Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration. The typical values are not tested and are not ensured on shipped production material.

<sup>(4)</sup> For test schematic, refer to Figure 35.

<sup>(5)</sup> I<sub>BI</sub> is referred to a differential output offset voltage by the following relationship: V<sub>OD(OFFSET)</sub> = I<sub>BI</sub>\*2R<sub>F</sub>.



# +5V Electrical Characteristics (1) (continued)

Unless otherwise specified, all limits are ensured for  $T_A = +25^{\circ}C$ ,  $A_V = +2$ ,  $V^+ = +2.5V$ ,  $V^- = -2.5V$ ,  $R_L = 200\Omega$ ,  $V_{CM} = (V^+ + V^-)/2$ ,  $R_F = 200\Omega$ , for single-ended in, differential out. Boldface Limits apply at the temperature extremes.

| Symbol            | Parameter                          | Conditions   | Min <sup>(2)</sup> | Typ <sup>(3)</sup> | Max (2)           | Units |
|-------------------|------------------------------------|--|--------------------|--------------------|-------------------|-------|
| R <sub>IN</sub>   | Differential Input Resistance      | Differential   |                    | 19                 |                   | Ω     |
| C <sub>IN</sub>   | Differential Input Capacitance     | Differential   |                    | 1                  |                   | pF    |
| CMVR              | Input Common Mode Voltage Range    | CMRR > 32 dB   | ±1.25              | ±1.3               |                   | V     |
| Output Pe         | rformance                          |  |                    |                    |                   |       |
|                   | Output Voltage Swing (3)           | Single-Ended Output  | ±1.35              | ±1.42              |                   | V     |
| I <sub>OUT</sub>  | Output Current (3)                 | V <sub>OUT</sub> = 0V  | ±120               | ±150               |                   | mA    |
| I <sub>SC</sub>   | Short Circuit Current              | One Output Shorted to Ground V <sub>IN</sub> = 2V Single-Ended <sup>(6)</sup>                                |                    | 150                |                   | mA    |
|                   | Output Balance Error               | $\Delta$ VOUT Common Mode / $\Delta$ V <sub>OUT</sub> Differential, $\Delta$ V <sub>OD</sub> = 1V, f < 1 Mhz |                    | -64                |                   | dB    |
| Output Co         | mmon Mode Control Circuit          |  |                    |                    |                   |       |
|                   | Common Mode Small Signal Bandwidth | $V_{IN^+} = V_{IN^-} = 0V$   |                    | 500                |                   | MHz   |
|                   | Slew Rate                          | $V_{IN^+} = V_{IN^-} = 0V$   |                    | 200                |                   | V/µs  |
| V <sub>OSCM</sub> | Input Offset Voltage               | Common Mode, V <sub>ID</sub> = 0, V <sub>CM</sub> = 0V   | -16                | -6.5               | 4                 | mV    |
| I <sub>OSCM</sub> | Input Offset Current               | (7)  |                    | 6                  | 18                | μΑ    |
|                   | Voltage Range                      |  | ±1.18              | ±1.25              |                   | V     |
|                   | CMRR                               | Measure V <sub>OD</sub> , V <sub>ID</sub> = 0V   |                    | 82                 |                   | dB    |
|                   | Input Resistance                   |  |                    | 180                |                   | kΩ    |
|                   | Gain                               | $\Delta V_{OCM}/\Delta V_{CM}$   | 0.99               | 0.995              | 1.0               | V/V   |
| Miscellane        | ous Performance                    |  |                    |                    |                   |       |
| $Z_T$             | Open Loop Transimpedance Gain      | Differential   |                    | 180                |                   | kΩ    |
| PSRR              | Power Supply Rejection Ratio       | DC, $\Delta V^+ = \Delta V^- = 1V$   | 74                 | 95                 |                   | dB    |
| Is                | Supply Current (8)                 | R <sub>L</sub> = ∞   | 46                 | 52                 | 57<br><b>60</b>   | mA    |
|                   | Enable Voltage Threshold           | Single 5V Supply (9)   |                    | 2.5                |                   | V     |
|                   | Disable Voltage Threshold          | Single 5V Supply (9)   |                    | 2.5                |                   | V     |
|                   | Enable/Disable Time                |  |                    | 15                 |                   | ns    |
| I <sub>SD</sub>   | Supply Current, Disabled           | Enable=0, Single 5V supply   | 450                | 510                | 570<br><b>600</b> | μΑ    |

<sup>(6)</sup> Short circuit current should be limited in duration to no more than 10 seconds. See the Power Dissipation section of Application Information for more details.

<sup>(7)</sup> Negative input current implies current flowing out of the device.

<sup>(8)</sup> Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration. The typical values are not tested and are not ensured on shipped production material.

<sup>(9)</sup>  $\dot{V}_{EN}$  threshold is typically +/-0.3V centered around (V<sup>+</sup> + V<sup>-</sup>) / 2 relative to ground.



# **Connection Diagram**

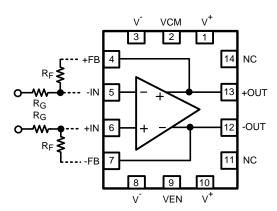


Figure 2. 14 Lead UQFN - Top View See Package Number NHJ0014A

Copyright © 2008–2013, Texas Instruments Incorporated



# Typical Performance Characteristics $V_s = \pm 2.5V$

 $(T_A = 25^{\circ}C, R_F = 200\Omega, R_G = 90\Omega, R_T = 76.8\Omega, R_L = 200\Omega, A_V = +2, for single ended in, differential out, unless specified).$ 

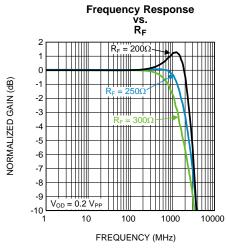


Figure 3.

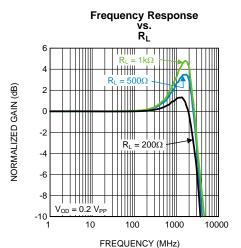
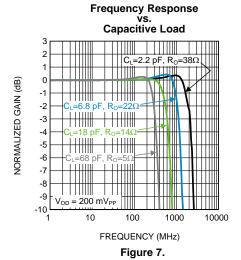


Figure 5.



Frequency Response vs. Gain

2
1
0
1
-1
-2
-3
-4
-5
-6
-6
-7
-8
-9
-10
1
10
1100
1000
10000

FREQUENCY (MHz)
Figure 4.

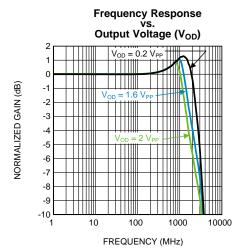


Figure 6.

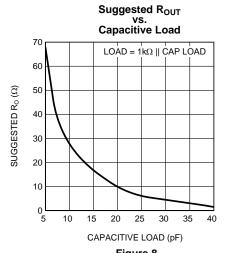
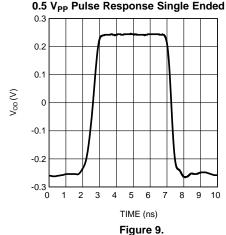


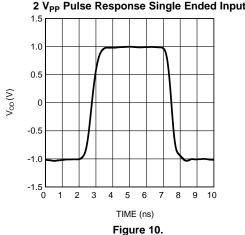
Figure 8.

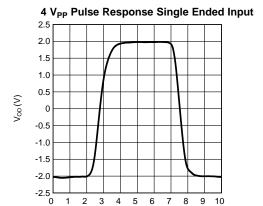


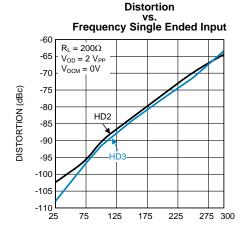
# Typical Performance Characteristics $V_S = \pm 2.5V$ (continued)

 $(T_A = 25^{\circ}C, \ R_F = 200\Omega, \ R_G = 90\Omega, \ R_T = 76.8\Omega, \ R_L = 200\Omega, \ A_V = +2, \ \text{for single ended in, differential out, unless specified)}.$   $\textbf{0.5 V}_{PP} \ \textbf{Pulse Response Single Ended Input} \ \textbf{2 V}_{PP} \ \textbf{Pulse Response Single Ended Input}$ 

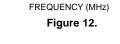


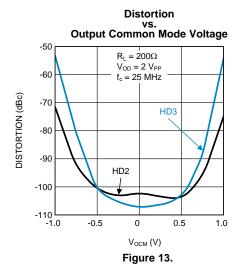






TIME (ns)
Figure 11.





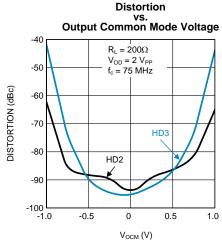


Figure 14.



# Typical Performance Characteristics $V_s = \pm 2.5V$ (continued)

 $(T_A = 25^{\circ}C, R_F = 200\Omega, R_G = 90\Omega, R_T = 76.8\Omega, R_L = 200\Omega, A_V = +2$ , for single ended in, differential out, unless specified).

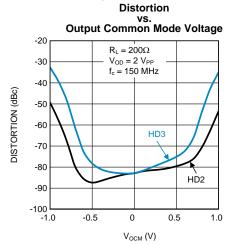


Figure 15.

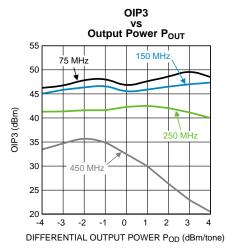
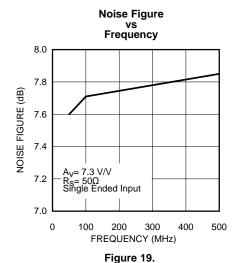


Figure 17.



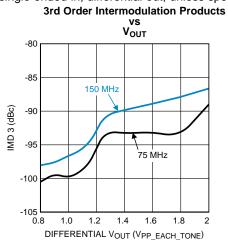


Figure 16.

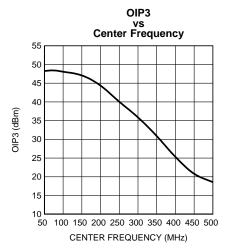


Figure 18.

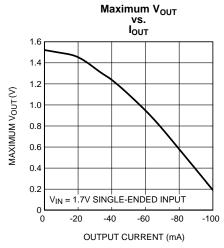


Figure 20.



# Typical Performance Characteristics $V_S = \pm 2.5V$ (continued)

 $(T_A = 25^{\circ}C, R_F = 200\Omega, R_G = 90\Omega, R_T = 76.8\Omega, R_L = 200\Omega, A_V = +2, for single ended in, differential out, unless specified).$ 

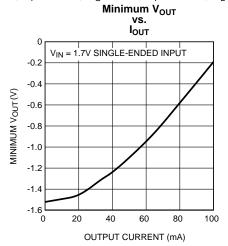


Figure 21.

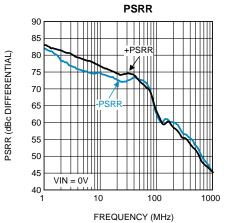
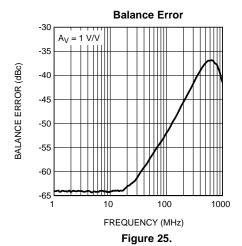


Figure 23.



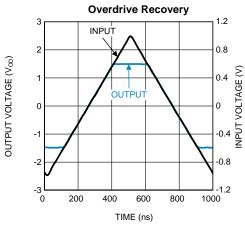


Figure 22.

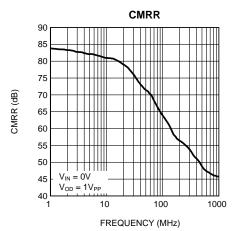


Figure 24.

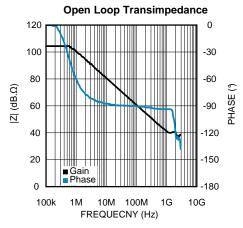


Figure 26.

Submit Documentation Feedback



# Typical Performance Characteristics $V_S = \pm 2.5V$ (continued)

Product Folder Links: LMH6554

 $(T_A = 25^{\circ}C, R_F = 200\Omega, R_G = 90\Omega, R_T = 76.8\Omega, R_L = 200\Omega, A_V = +2$ , for single ended in, differential out, unless specified).

# **Closed Loop Output Impedance** 1k 100 $\frac{\widehat{G}}{\underline{N}}$ 10 100m 100 FREQUENCY (MHz)

Figure 27.

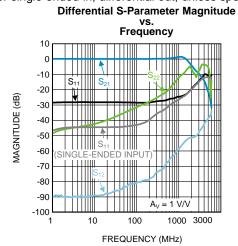


Figure 28.



#### **APPLICATION INFORMATION**

The LMH6554 is a fully differential, current feedback amplifier with integrated output common mode control, designed to provide low distortion amplification to wide bandwidth differential signals. The common mode feedback circuit sets the output common mode voltage independent of the input common mode, as well as forcing the  $V^+$  and  $V^-$  outputs to be equal in magnitude and opposite in phase, even when only one of the inputs is driven as in single to differential conversion.

The proprietary current feedback architecture of the LMH6554 offers gain and bandwidth independence with exceptional gain flatness and noise performance, even at high values of gain, simply with the appropriate choice of  $R_{F1}$  and  $R_{F2}$ . Generally  $R_{F1}$  is set equal to  $R_{F2}$ , and  $R_{G1}$  equal to  $R_{G2}$ , so that the gain is set by the ratio  $R_F/R_G$ . Matching of these resistors greatly affects CMRR, DC offset error, and output balance. A maximum of 0.1% tolerance resistors are recommended for optimal performance, and the amplifier is internally compensated to operate with optimum gain flatness with  $R_F$  value of 200 $\Omega$  depending on PCB layout, and load resistance.

The output common mode voltage is set by the  $V_{CM}$  pin with a fixed gain of 1 V/V. This pin should be driven by a low impedance reference and should be bypassed to ground with a 0.1  $\mu$ F ceramic capacitor. Any unwanted signal coupling into the  $V_{CM}$  pin will be passed along to the outputs, reducing the performance of the amplifier.

The LMH6554 can be configured to operate on a single 5V supply connected to V+ with V- grounded or configured for a split supply operation with  $V^+ = +2.5V$  and  $V^- = -2.5V$ . Operation on a single 5V supply, depending on gain, is limited by the input common mode range; therefore, AC coupling may be required. Split supplies will allow much less restricted AC and DC coupled operation with optimum distortion performance.

## **Enable / Disable Operation**

The LMH6554 is equipped with an enable pin  $(V_{EN})$  to reduce power consumption when not in use. The  $V_{EN}$  pin, when not driven, floats high (on). When the  $V_{EN}$  pin is pulled low, the amplifier is disabled and the amplifier output stage goes into a high impedance state so the feedback and gain set resistors determine the output impedance of the circuit. For this reason input to output isolation will be poor in the disabled state and the part is not recommended in multiplexed applications where outputs are all tied together.

With a 5V difference between  $V^+$  and  $V^-$ , the  $V_{EN}$  threshold is ½ way between the supplies (e.g. 2.5V with 5V single supply) as shown in Figure 29. R2 ensures active (enable) mode with  $V_{EN}$  floating, and R1 provides input current limiting.  $V_{EN}$  also has ESD diodes to either supply.

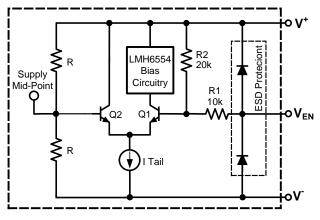


Figure 29. Enable Block Diagram

## **Fully Differential Operation**

The LMH6554 will perform best in a fully differential configuration. The circuit shown in Figure 30 is a typical fully differential application circuit as might be used to drive an analog to digital converter (ADC). In this circuit the closed loop gain is  $A_V = V_{OUT} / V_{IN} = R_F / R_G$ , where the feedback is symmetric. The series output resistors,  $R_O$ , are optional and help keep the amplifier stable when presented with a capacitive load. Refer to the Driving Capacitive Loads section for details.



Here is the expression for the input impedance, R<sub>IN</sub>, as defined in Figure 30:

$$R_{IN} = 2R_{G}$$

When driven from a differential source, the LMH6554 provides low distortion, excellent balance, and common mode rejection. This is true provided the resistors  $R_F$ ,  $R_G$  and  $R_O$  are well matched and strict symmetry is observed in board layout. With an intrinsic device CMRR of greater than 70 dB, using 0.1% resistors will give a worst case CMRR of around 50 dB for most circuits.

The circuit configuration shown in Figure 30 was used to measure differential S-parameters in a  $100\Omega$  environment at a gain of 1 V/V. Refer to Figure 28 in Typical Performance Characteristics  $V_S = \pm 2.5V$  for measurement results.

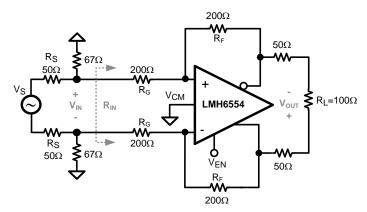


Figure 30. Differential S-Parameter Test Circuit

## Single Ended Input To Differential Output Operation

In many applications, it is required to drive a differential input ADC from a single ended source. Traditionally, transformers have been used to provide single to differential conversion, but these are inherently bandpass by nature and cannot be used for DC coupled applications. The LMH6554 provides excellent performance as a single-ended input to differential output converter down to DC. Figure 31 shows a typical application circuit where an LMH6554 is used to produce a balanced differential output signal from a single ended source.

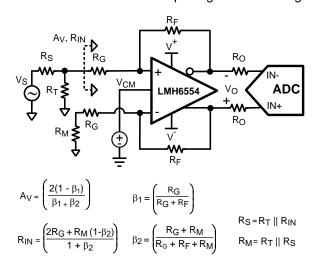


Figure 31. Single Ended Input with Differential Output



When using the LMH6554 in single-to-differential mode, the complimentary output is forced to a phase inverted replica of the driven output by the common mode feedback circuit as opposed to being driven by its own complimentary input. Consequently, as the driven input changes, the common mode feedback action results in a varying common mode voltage at the amplifier's inputs, proportional to the driving signal. Due to the non-ideal common mode rejection of the amplifier's input stage, a small common mode signal appears at the outputs which is superimposed on the differential output signal. The ratio of the change in output common mode voltage to output differential voltage is commonly referred to as output balance error. The output balance error response of the LMH6554 over frequency is shown in the Typical Performance Characteristics  $V_S = \pm 2.5V$ .

To match the input impedance of the circuit in Figure 31 to a specified source resistance,  $R_S$ , requires that  $R_T \parallel R_{IN} = R_S$ . The equations governing  $R_{IN}$  and  $A_V$  for single-to-differential operation are also provide in Figure 31. These equations, along with the source matching condition, must be solved iteratively to achieve the desired gain with the proper input termination. Component values for several common gain configuration in a  $50\Omega$  environment are given in Table 1.

|      |                | -       | •              |         |
|------|----------------|---------|----------------|---------|
| Gain | R <sub>F</sub> | $R_{G}$ | R <sub>T</sub> | $R_{M}$ |
| 0dB  | 200Ω           | 191Ω    | 62Ω            | 27.7Ω   |
| 6dB  | 200Ω           | 91Ω     | 76.8Ω          | 30.3Ω   |
| 12dB | 200Ω           | 35.7Ω   | 147Ω           | 37.3Ω   |

Table 1. Gain Component Values for 50Ω System

#### **Single Supply Operation**

Single 5V supply operation is possible: however, as discussed earlier, AC input coupling is recommended due to input common mode limitations. An example of an AC coupled, single supply, single-to-differential circuit is shown in Figure 32. Note that when AC coupling, both inputs need to be AC coupled irrespective of single-to-differential or differential-differential configuration. For higher supply voltages DC coupling of the inputs may be possible provided that the output common mode DC level is set high enough so that the amplifier's inputs and outputs are within their specified operation ranges.

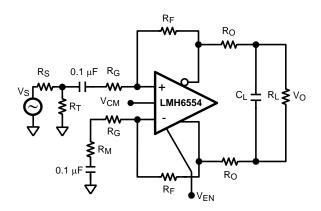


Figure 32. AC Coupled for Single Supply Operation

Product Folder Links: LMH6554



## Split Supply Operation

For optimum performance, split supply operation is recommended using +2.5V and -2.5V supplies; however, operation is possible on split supplies as low as +2.35V and -2.35V and as high as +2.65V and -2.65V. Provided the total supply voltage does not exceed the 4.7V to 5.3V operating specification, non-symmetric supply operation is also possible and in some cases advantageous. For example, if a 5V DC coupled operation is required for low power dissipation but the amplifier input common mode range prevents this operation, it is still possible with split supplies of (V+) and (V-). Where (V+)-(V-)=5V and V+ and V- are selected to center the amplifier input common mode range to suit the application.

## **Driving Analog To Digital Converters**

Analog-to-digital converters present challenging load conditions. They typically have high impedance inputs with large and often variable capacitive components. Figure 34 shows the LMH6554 driving an ultra-high-speed Gigasample ADC the ADC10D1500. The LMH6554 common mode voltage is set by the ADC10D1500. The circuit in Figure 34 has a 2nd order bandpass LC filter across the differential inputs of the ADC10D1500. The ADC10D1500 is a dual channel 10—bit ADC with maximum sampling rate of 3 GSPS when operating in a single channel mode and 1.5 GSPS in dual channel mode.

Figure 33 shows the SFDR and SNR performance vs. frequency for the LMH6554 and ADC10D1500 combination circuit with the ADC input signal level at -1dBFS. In order to properly match the input impedance seen at the LMH6554 amplifier inputs,  $R_M$  is chosen to match  $Z_S \parallel R_T$  for proper input balance. The amplifier is configured to provide a gain of 2 V/V in single to differential mode. An external bandpass filter is inserted in series between the input signal source and the amplifier to reduce harmonics and noise from the signal generator.

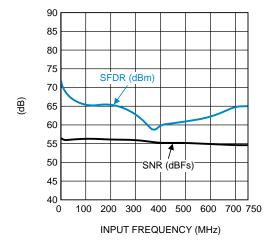


Figure 33. LMH6554 / ADC10D1500 SFDR and SNR Performance vs. Frequency

The amplifier and ADC should be located as close together as possible. Both devices require that the filter components be in close proximity to them. The amplifier needs to have minimal parasitic loading on it's outputs and the ADC is sensitive to high frequency noise that may couple in on its inputs. Some high performance ADCs have an input stage that has a bandwidth of several times its sample rate. The sampling process results in all input signals presented to the input stage mixing down into the first Nyquist zone (DC to Fs/2).



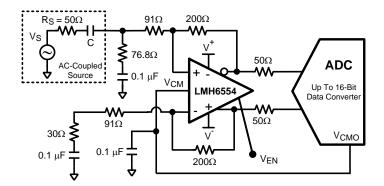


Figure 34. Driving a 10-bit Gigasample ADC

#### **Output Noise Performance and Measurement**

Unlike differential amplifiers based on voltage feedback architectures, noise sources internal to the LMH6554 refer to the inputs largely as current sources, hence the low input referred voltage noise and relatively higher input referred current noise. The output noise is therefore more strongly coupled to the value of the feedback resistor and not to the closed loop gain, as would be the case with a voltage feedback differential amplifier. This allows operation of the LMH6554 at much higher gain without incurring a substantial noise performance penalty, simply by choosing a suitable feedback resistor.

Figure 35 shows a circuit configuration used to measure noise figure for the LMH6554 in a  $50\Omega$  system. A feedback resistor value of  $200\Omega$  is chosen for the UQFN package to minimize output noise while simultaneously allowing both high gain (7 V/V) and proper  $50\Omega$  input termination. Refer to Single Ended Input To Differential Output Operation for the calculation of resistor and gain values.

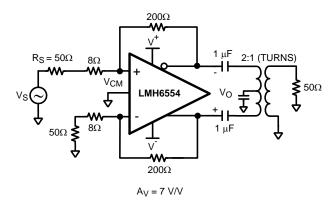


Figure 35. Noise Figure Circuit Configuration

#### **Driving Capacitive Loads**

As noted previously, capacitive loads should be isolated from the amplifier output with small valued resistors. This is particularly the case when the load has a resistive component that is  $500\Omega$  or higher. A typical ADC has capacitive components of around 10 pF and the resistive component could be  $1000\Omega$  or higher. If driving a transmission line, such as  $50\Omega$  coaxial or  $100\Omega$  twisted pair, using matching resistors will be sufficient to isolate any subsequent capacitance. For other applications see Figure 8 in Typical Performance Characteristics  $V_S = \pm 2.5V$ .



#### **Balanced Cable Driver**

With up to 5.68 V<sub>PP</sub> differential output voltage swing the LMH6554 can be configured as a cable driver. The LMH6554 is also suitable for driving differential cables from a single ended source as shown in Figure 36.

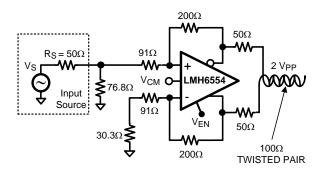


Figure 36. Fully Differential Cable Driver

## **Power Supply Bypassing**

The LMH6554 requires supply bypassing capacitors as shown in Figure 37 and Figure 38. The 0.01  $\mu$ F and 0.1  $\mu$ F capacitors should be leadless SMT ceramic capacitors and should be no more than 3 mm from the supply pins. These capacitors should be star routed with a dedicated ground return plane or trace for best harmonic distortion performance. Thin traces or small vias will reduce the effectiveness of bypass capacitors. Also shown in both figures is a capacitor from the VCM and  $V_{EN}$  pins to ground. These inputs are high impedance and can provide a coupling path into the amplifier for external noise sources, possibly resulting in loss of dynamic range, degraded CMRR, degraded balance and higher distortion.

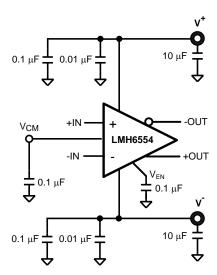


Figure 37. Split Supply Bypassing Capacitors



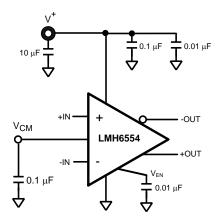


Figure 38. Single Supply Bypassing Capacitors

#### **Power Dissipation**

The LMH6554 is optimized for maximum speed and performance in a small form factor 14 lead UQFN package. To ensure maximum output drive and highest performance, thermal shutdown is not provided. Therefore, it is of utmost importance to make sure that the  $T_{\text{JMAX}}$  is never exceeded due to the overall power dissipation.

Follow these steps to determine the maximum power dissipation for the LMH6554:

1. Calculate the quiescent (no-load) power:

$$P_{AMP} = I_{CC} * (V_S)$$

#### where

• 
$$V_S = V^+ - V^-$$
. (Be sure to include any current through the feedback network if  $V_{CM}$  is not mid-rail) (1)

2. Calculate the RMS power dissipated in each of the output stages:

$$P_{D}$$
 (rms) = rms (( $V_{S} - V_{OUT}$ ) \*  $I_{OUT}$ ) + rms (( $V_{S} - V_{OUT}$ ) \*  $I_{OUT}$ )

#### where

- V<sub>OUT</sub> and I<sub>OUT</sub> are the voltage
- the current measured at the output pins of the differential amplifier as if they were single ended amplifiers
- V<sub>S</sub> is the total supply voltage (2)

3. Calculate the total RMS power:

$$P_{T} = P_{AMP} + P_{D} \tag{3}$$

The maximum power that the LMH6554 package can dissipate at a given temperature can be derived with the following equation:

$$P_{MAX} = (150^{\circ} - T_{AMB})/\theta_{JA}$$

#### where

- T<sub>AMB</sub> = Ambient temperature (°C)
- $\theta_{JA}$  = Thermal resistance, from junction to ambient, for a given package (°C/W)
- For the 14 lead UQFN package,  $\theta_{JA}$  is 60°C/W (4)

#### NOTE

If  $V_{CM}$  is not 0V then there will be quiescent current flowing in the feedback network. This current should be included in the thermal calculations and added into the quiescent power dissipation of the amplifier.



#### **ESD Protection**

The LMH6554 is protected against electrostatic discharge (ESD) on all pins. The LMH6554 will survive 2000V Human Body model and 250V Machine model events. Under normal operation the ESD diodes have no affect on circuit performance. There are occasions, however, when the ESD diodes will be evident. If the LMH6554 is driven by a large signal while the device is powered down the ESD diodes will conduct. The current that flows through the ESD diodes will either exit the chip through the supply pins or will flow through the device, hence it is possible to power up a chip with a large signal applied to the input pins. Using the shutdown mode is one way to conserve power and still prevent unexpected operation.

#### **Board Layout**

The LMH6554 is a high speed, high performance amplifier. In order to get maximum benefit from the differential circuit architecture board layout and component selection is very critical. The circuit board should have a low inductance ground plane and well bypassed broad supply lines. External components should be leadless surface mount types. The feedback network and output matching resistors should be composed of short traces and precision resistors (0.1%). The output matching resistors should be placed within 3 or 4 mm of the amplifier as should the supply bypass capacitors. Refer to Power Supply Bypassing for recommendations on bypass circuit layout. Evaluation boards are available through the product folder on ti.com.

By design, the LMH6554 is relatively insensitive to parasitic capacitance at its inputs. Nonetheless, ground and power plane metal should be removed from beneath the amplifier and from beneath  $R_{\text{F}}$  and  $R_{\text{G}}$  for best performance at high frequency.

With any differential signal path, symmetry is very important. Even small amounts of asymmetry can contribute to distortion and balance errors.

#### **Evaluation Board**

See LMH6554 Product Folder for evaluation board availability and ordering information.

Product Folder Links: *LMH6554* 

Copyright © 2008-2013, Texas Instruments Incorporated



# **REVISION HISTORY**

| Changes from Revision N (March 2013) to Revision O |  |      |  |  |  |
|--|--|------|--|--|--|
| •  | Changed layout of National Data Sheet to TI format | . 18 |  |  |  |



# PACKAGE OPTION ADDENDUM

11-Apr-2013

#### PACKAGING INFORMATION

www.ti.com

| Orderable Device | Status | Package Type | Package | Pins | Package | Eco Plan                   | Lead/Ball Finish | MSL Peak Temp       | Op Temp (°C) | Top-Side Markings | Samples |
|------------------|--------|--------------|---------|------|---------|----------------------------|------------------|---------------------|--------------|-------------------|---------|
|                  | (1)    |              | Drawing |      | Qty     | (2)                        |                  | (3)                 |              | (4)               |         |
| LMH6554LE/NOPB   | ACTIVE | UQFN         | NHJ     | 14   | 1000    | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-3-260C-168 HR | -40 to 125   | AJA               | Samples |
| LMH6554LEE/NOPB  | ACTIVE | UQFN         | NHJ     | 14   | 250     | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-3-260C-168 HR | -40 to 125   | AJA               | Samples |
| LMH6554LEX/NOPB  | ACTIVE | UQFN         | NHJ     | 14   | 4500    | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-3-260C-168 HR | -40 to 125   | AJA               | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): Tl's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, Tl Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Multiple Top-Side Markings will be inside parentheses. Only one Top-Side Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Top-Side Marking for that device.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

# PACKAGE MATERIALS INFORMATION

www.ti.com 26-Mar-2013

# TAPE AND REEL INFORMATION





|    | Dimension designed to accommodate the component width     |
|----|---|
|    | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

## QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

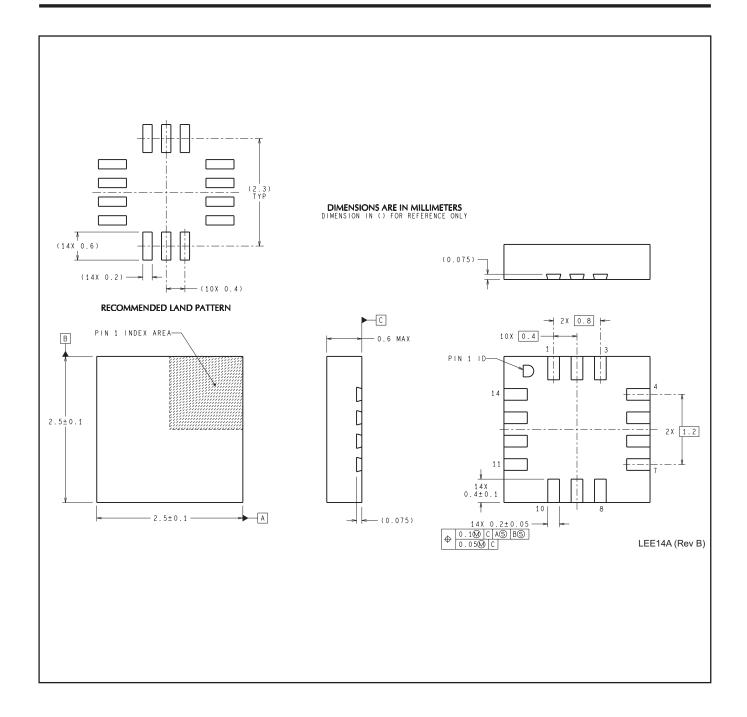
| Device          | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|-----------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| LMH6554LE/NOPB  | UQFN            | NHJ                | 14 | 1000 | 178.0                    | 12.4                     | 2.8        | 2.8        | 1.0        | 8.0        | 12.0      | Q1               |
| LMH6554LEE/NOPB | UQFN            | NHJ                | 14 | 250  | 178.0                    | 12.4                     | 2.8        | 2.8        | 1.0        | 8.0        | 12.0      | Q1               |
| LMH6554LEX/NOPB | UQFN            | NHJ                | 14 | 4500 | 330.0                    | 12.4                     | 2.8        | 2.8        | 1.0        | 8.0        | 12.0      | Q1               |

www.ti.com 26-Mar-2013



#### \*All dimensions are nominal

| 7 til diritoriororio di o riorimidi |              |                 |      |      |             |            |             |
|-------------------------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| Device                              | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
| LMH6554LE/NOPB                      | UQFN         | NHJ             | 14   | 1000 | 213.0       | 191.0      | 55.0        |
| LMH6554LEE/NOPB                     | UQFN         | NHJ             | 14   | 250  | 213.0       | 191.0      | 55.0        |
| LMH6554LEX/NOPB                     | UQFN         | NHJ             | 14   | 4500 | 367.0       | 367.0      | 35.0        |



#### IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have *not* been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Products Applications

Audio www.ti.com/audio Automotive and Transportation www.ti.com/automotive Communications and Telecom **Amplifiers** amplifier.ti.com www.ti.com/communications **Data Converters** dataconverter.ti.com Computers and Peripherals www.ti.com/computers **DLP® Products** www.dlp.com Consumer Electronics www.ti.com/consumer-apps

DSP **Energy and Lighting** dsp.ti.com www.ti.com/energy Clocks and Timers www.ti.com/clocks Industrial www.ti.com/industrial Interface interface.ti.com Medical www.ti.com/medical logic.ti.com Logic Security www.ti.com/security

Power Mgmt power.ti.com Space, Avionics and Defense www.ti.com/space-avionics-defense

Microcontrollers <u>microcontroller.ti.com</u> Video and Imaging <u>www.ti.com/video</u>

RFID www.ti-rfid.com

OMAP Applications Processors <a href="www.ti.com/omap">www.ti.com/omap</a> TI E2E Community <a href="e2e.ti.com">e2e.ti.com</a>

Wireless Connectivity <u>www.ti.com/wirelessconnectivity</u>